



Docket No.: 2852-C

Confirmation No. 1630

Group Art Unit: 1646

Examiner: E. Lazar Wesley

For: ISOLATED DNA MOLECULE ENCODING RANK LIGAND

## INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents  
Washington, DC 20231

The material listed on the accompanying Form PTO-1449 is cited in compliance with 37 C.F.R. §§ 1.56 and 1.97 through 1.98. Kindly acknowledge receipt of this Statement and make the cited references of record in the subject application.

The aforesaid references are made known to the Patent and Trademark Office in compliance with applicants' duty to disclose all information they are aware of which may be relevant to the examination of the above-identified application. Certain of the references listed on the attached Form PTO-1449 were published after the filing date of one or more of the prior applications from which the present application claims the benefit of priority.

A copy of the following references are enclosed: U.S. Patent No. 6,242,586, and U.S. Patent No. 6,316,408. Each of the remaining references listed on the enclosed Form PTO-1449 was previously submitted to the U.S. P.T.O. in an Information Disclosure Statement that complies with 37 C.F.R. § 1.98 (a) to (c), in parent application serial no. 08/995,659.

This Information Disclosure Statement is submitted under 37 C.F.R. §1.97(c) and the Commissioner is authorized to charge the \$180 fee and any other fees which may be required to Deposit Account No. 09-0089. A duplicate copy of this sheet is enclosed.

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Respectfully submitted,

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## CERTIFICATE OF MAILING

I hereby certify that this Information Disclosure Statement is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, on the date indicated below.

Date: April 10, 2002

Signed: